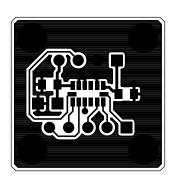
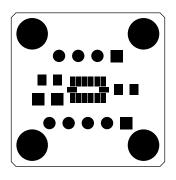


Primary (Top) Silkscreen



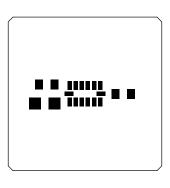
301-350 PRI

First (Top) Copper Layer



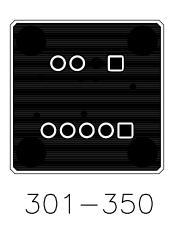
301-350 PSM

Primary (Top) Soldermask



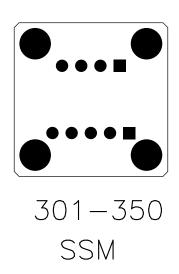
301-350 PPM

Primary (Top) Pastemask



SEC

Second (Bottom) Copper Layer



Secondary (Bottom) Soldermask

SPECIFICATIONS:

MATERIAL: - G10 OR FR-4, GLASS EPOXY .090", 1 OUNCE OF COPPER.

PROCESS: - SMOBC.

- MINIMUM TRACES 0.012", MINIMUM SPACING 0.012"

- ALL HOLES ARE PLATED WITH 1 OUNCE OF COPPER.

- MAKE SURE THE ASPECT RATIO MEET YOUR CAPABILITY.

PLATED

YES

YES

YES

TOL

+0.003/-0.012

+/-0.003

+/-0.0

- DIMENSIONS FOR DRILLING ARE GIVEN AFTER PLATING.

- DRILLING TOLERANCES ARE +/-.003"

SOLDER MASK: - TYPE UV OR PHOTO IMAGEABLE OR EQUIVALENT.

SILKSCREEN: - EPOXY ENAMEL WHITE.

SIZE

20

116

35

DRILLING: - USE 301-350.drl

DATA: - GERBER & DRILLING FILE ARE SUPPLIED BY:

QTY

6

4

9

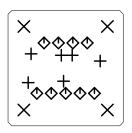
SYM

+

X

 \Diamond

INTEMPCO CONTROLS LTD



301 - 350

FAB